ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES	burn, Illinois, All rights reserved	under both This of level	document is a declar parts, the declaratio	ation of the su	bstances wi s all lower le	ithin the manufacture evel materials for wh	er listed item. I iich the manuf	Note: if the acturer has	item is an asse engineering res	mbly with lower ponsibility.	
IPC Web Site for Information on http://www.ipc.org/IPC-175x	IPC Web Site for Information on IPC-1752 Standard Form Ty   http://www.ipc.org/IPC-175x Distribu			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Infor				formation			
Supplier Information											
Company name*	pany name* Company unique ID			Unique ID Authority				Response Date*			
onsemi	<u>и</u>							2025-06-06			
Contact Name	Title - Contact		Phone - Con	Phone - Contact*				Email - Contact*			
Product-Env-Stewards	wards Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Enviro C		o Compliance		NA			Product-Env-Stewards@onsemi.com				
Requester Item Number Mfr Ite	m Number Mfr Item Name	Mfr Item Name		te Version	Ma	Manufacturing Site		ht*	UOM	Unit Type	
SZBZX	84C24ET1G ZEN SOT23 RE	G .225W SPCL	2025-06-06		CN	1	8.02		mg	Each	
Manufacturing Proccess Information									•	·	
Terminal Plating / Grid Array Material	Terminal Base Alloy	J-STD-020 MSL Rati	ng Peak Pr	eak Process Body Temperature		Max Time at Peak	Femperature	Number of	f Reflow Cycle	5	
Matte Tin (Sn) - annealed CU Alloy 1		1	260		С	30	seconds	3			
Comments											
evel 1 - maximum time at peak temperature during s	oldering is 10-30 seconds										
For more information regarding material composition	please refer to page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the
Supplier Digital Signature Ra	stislav Drska	Le			

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.05	mg	Supplier	Silicon (Si)	7440-21-3		0.05	mg	
Lead Frame	2.92	mg	В	Nickel (Ni)	7440-02-0		1.06	mg	
			Supplier	Iron (Fe)	7439-89-6		1.4658	mg	
			Supplier	Copper (Cu)	7440-50-8		0.3942	mg	
Mold Compound-Black	4.9	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.49	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.0245	mg	
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.7105	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		3.185	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.49	mg	
Plating	0.14	mg	Supplier	Tin (Sn)	7440-31-5		0.14	mg	
Wire Bond - Au	0.01	mg	Supplier	Gold (Au)	7440-57-5		0.01	mg	